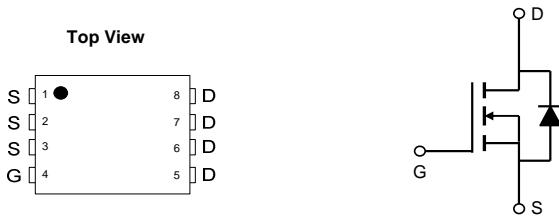


General Description

The AON6454A combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{DS(ON)}$. This device is ideal for boost converters and synchronous rectifiers for consumer, telecom, industrial power supplies and LED backlighting.

Features

V_{DS}	150V
I_D (at $V_{GS}=10V$)	31A
$R_{DS(ON)}$ (at $V_{GS}=10V$)	< 38mΩ
$R_{DS(ON)}$ (at $V_{GS}=7V$)	< 44mΩ



Absolute Maximum Ratings $T_A=25^\circ C$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DS}	150	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current	I_D	31	A
$T_C=100^\circ C$	I_D	20	
Pulsed Drain Current ^C	I_{DM}	65	
Continuous Drain Current	I_{DSM}	5	A
$T_A=70^\circ C$	I_{DSM}	4.0	
Avalanche Current ^C	I_{AS}, I_{AR}	12	A
Avalanche energy $L=0.1mH$ ^C	E_{AS}, E_{AR}	7	mJ
Power Dissipation ^B	P_D	83	W
$T_C=100^\circ C$	P_D	33	
Power Dissipation ^A	P_{DSM}	2.3	W
$T_A=70^\circ C$	P_{DSM}	1.5	
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	°C

Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient ^A $t \leq 10s$	$R_{\theta JA}$	14	17	°C/W
Maximum Junction-to-Ambient ^{A D} Steady-State		40	55	°C/W
Maximum Junction-to-Case	$R_{\theta JC}$	1	1.5	°C/W

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =250μA, V _{GS} =0V	150			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =150V, V _{GS} =0V T _J =55°C			1 5	μA
I _{GSS}	Gate-Body leakage current	V _{DS} =0V, V _{GS} =±20V			±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} I _D =250μA	3.4	4	4.6	V
I _{D(ON)}	On state drain current	V _{GS} =10V, V _{DS} =5V	65			A
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =20A T _J =125°C	31	38		mΩ
		V _{GS} =7V, I _D =20A	59	72		
g _{FS}	Forward Transconductance	V _{DS} =5V, I _D =20A	35			S
V _{SD}	Diode Forward Voltage	I _S =1A, V _{GS} =0V	0.69	1		V
I _S	Maximum Body-Diode Continuous Current ^G				85	A
DYNAMIC PARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =75V, f=1MHz	1365	1710	2055	pF
C _{oss}	Output Capacitance		100	150	200	pF
C _{rss}	Reverse Transfer Capacitance		30	50	70	pF
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz	0.5	1.1	1.7	Ω
SWITCHING PARAMETERS						
Q _g (10V)	Total Gate Charge	V _{GS} =10V, V _{DS} =75V, I _D =20A	25	32.5	40	nC
Q _g (4.5V)	Total Gate Charge		5	7.8	10	nC
Q _{gs}	Gate Source Charge			9.5		nC
Q _{gd}	Gate Drain Charge			13.5		nC
t _{D(on)}	Turn-On Delay Time	V _{GS} =10V, V _{DS} =75V, R _L =3.75Ω, R _{GEN} =3Ω		12		ns
t _r	Turn-On Rise Time			8		ns
t _{D(off)}	Turn-Off Delay Time			20		ns
t _f	Turn-Off Fall Time			4.5		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =10A, dI/dt=500A/μs		33		ns
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =10A, dI/dt=500A/μs		350		nC

A. The value of R_{0JA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A=25°C. The Power dissipation P_{DSM} is based on R_{0JA} and the maximum allowed junction temperature of 150°C. The value in any given application depends on the user's specific board design.

B. The power dissipation P_D is based on T_{J(MAX)}=150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C. Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=150°C. Ratings are based on low frequency and duty cycles to keep initial T_J=25°C.

D. The R_{0JA} is the sum of the thermal impedance from junction to case R_{0JC} and case to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using <300μs pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of T_{J(MAX)}=150°C. The SOA curve provides a single pulse rating.

G. The maximum current rating is package limited.

H. These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with T_A=25°C.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

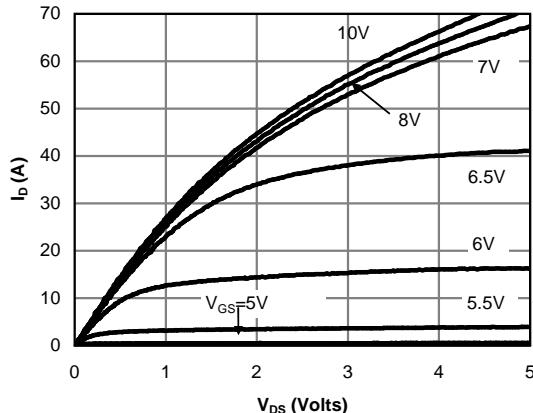


Fig 1: On-Region Characteristics (Note E)

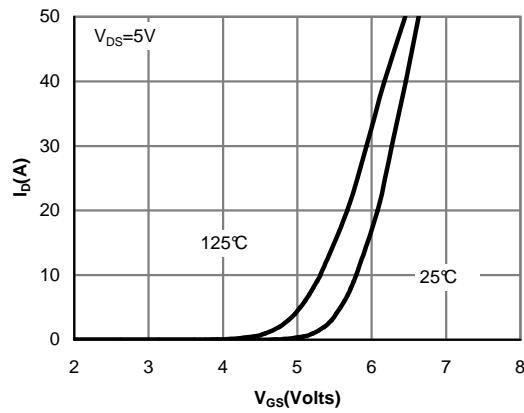


Figure 2: Transfer Characteristics (Note E)

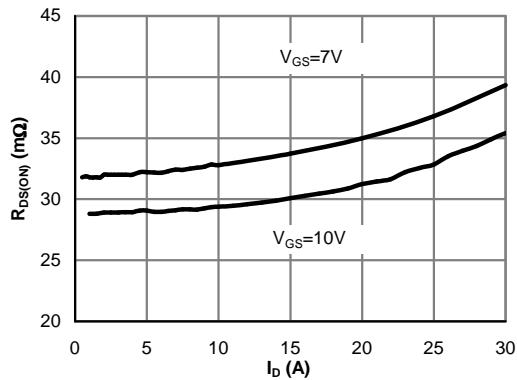


Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

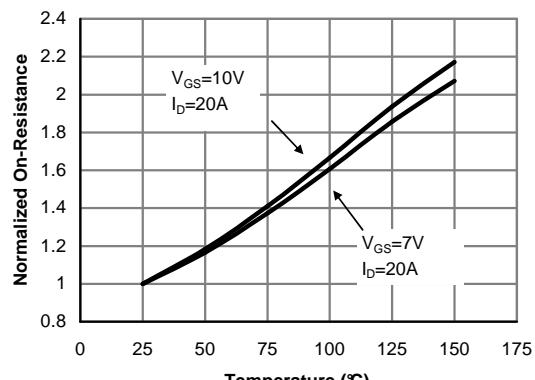


Figure 4: On-Resistance vs. Junction Temperature (Note E)

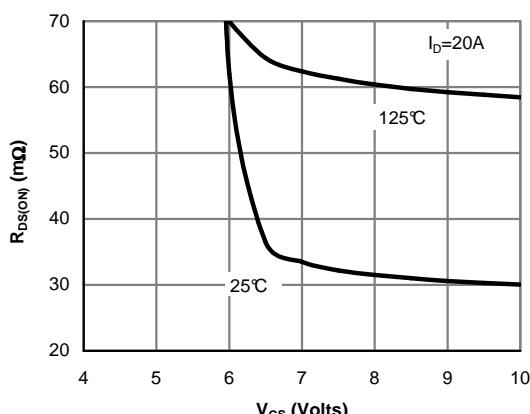


Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

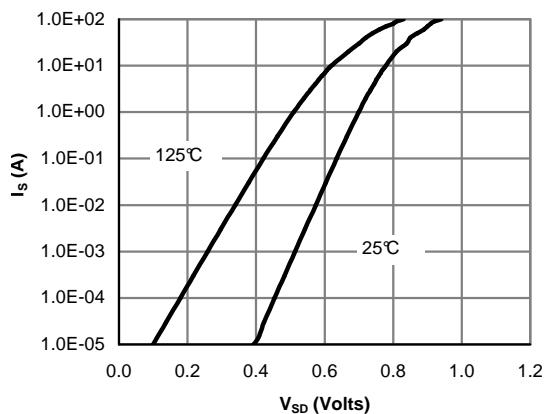
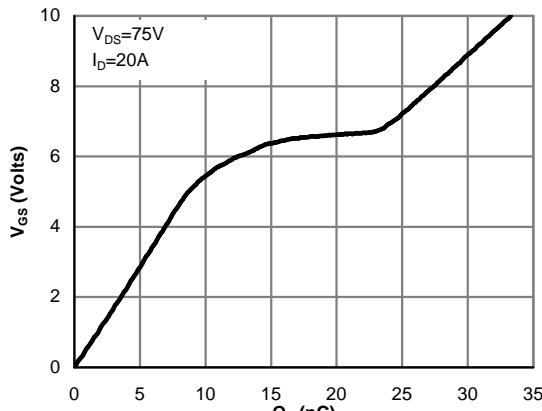
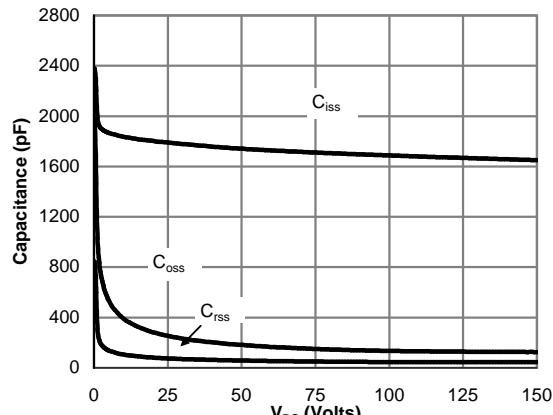
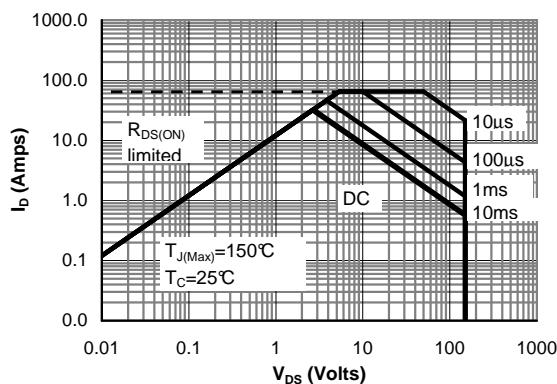
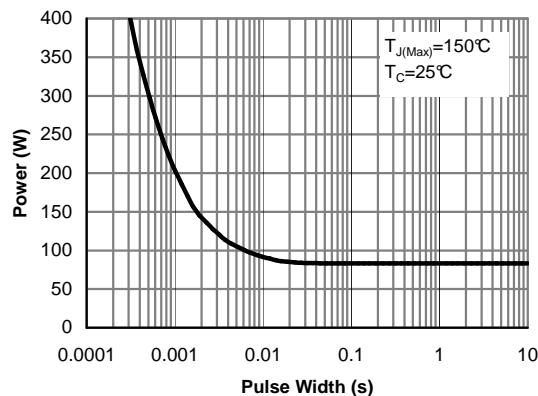
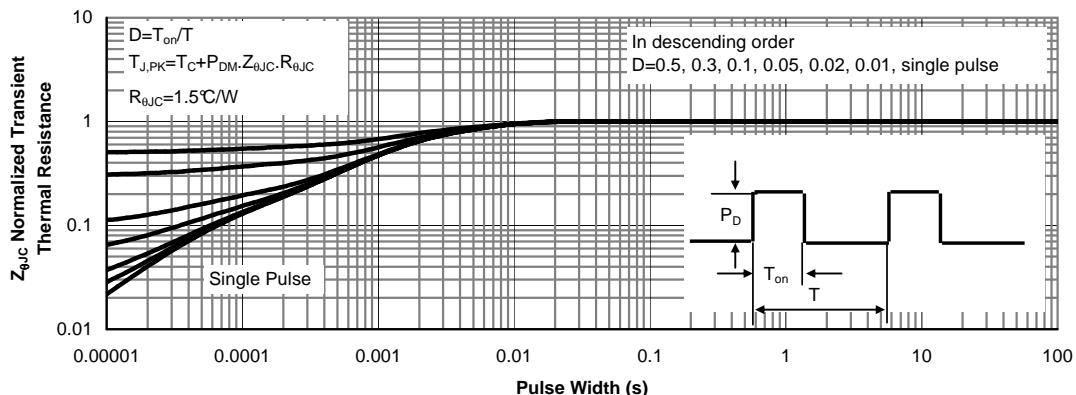


Figure 6: Body-Diode Characteristics (Note E)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

Figure 7: Gate-Charge Characteristics

Figure 8: Capacitance Characteristics

Figure 9: Maximum Forward Biased Safe Operating Area (Note F)

Figure 10: Single Pulse Power Rating Junction-to-Case (Note F)

Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

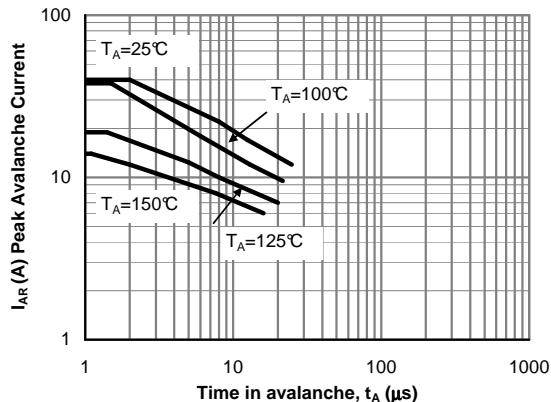


Figure 12: Single Pulse Avalanche capability
(Note C)

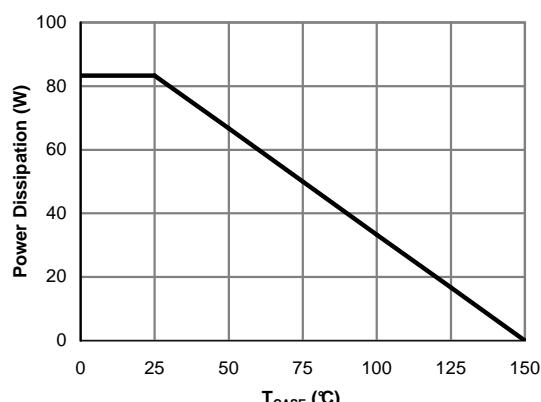


Figure 13: Power De-rating (Note F)

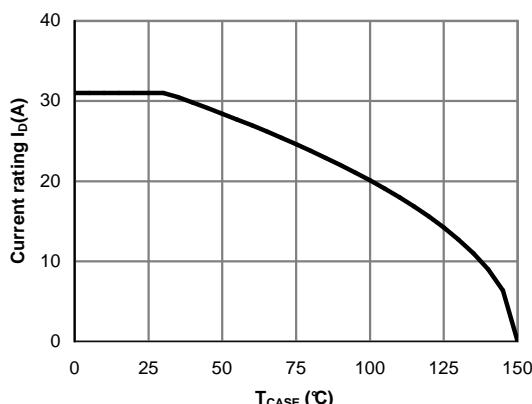


Figure 14: Current De-rating (Note F)

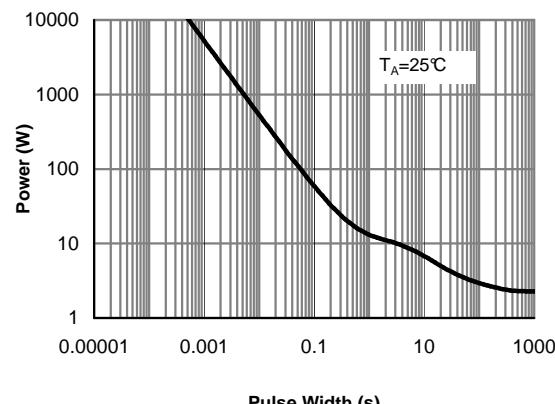


Figure 15: Single Pulse Power Rating Junction-to-Ambient (Note H)

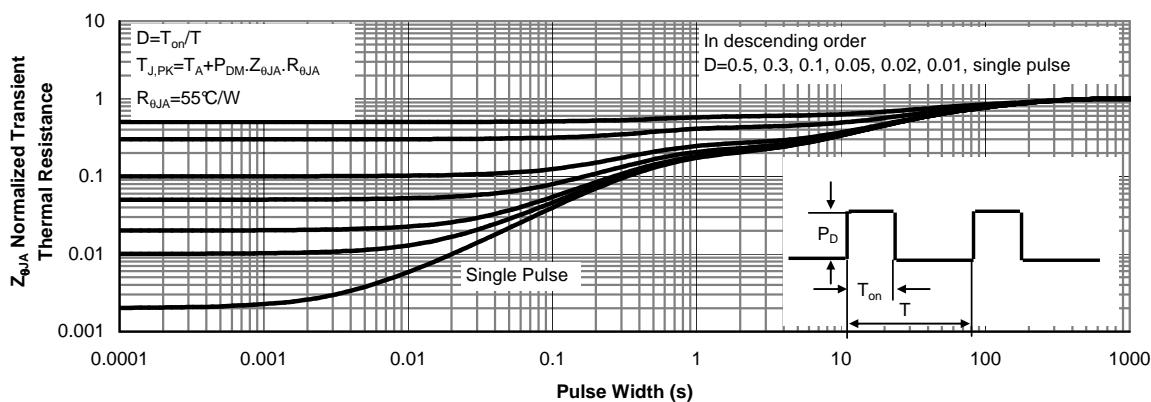
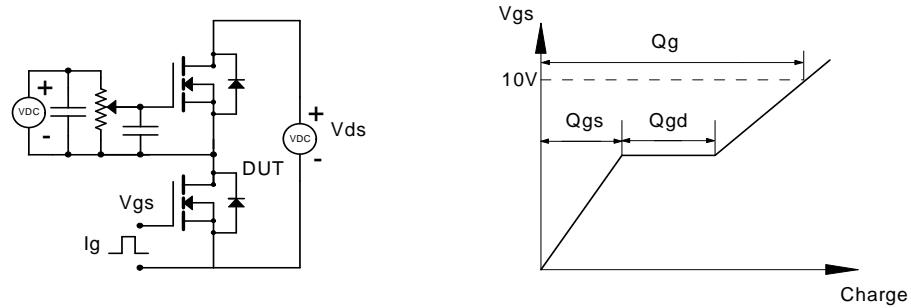
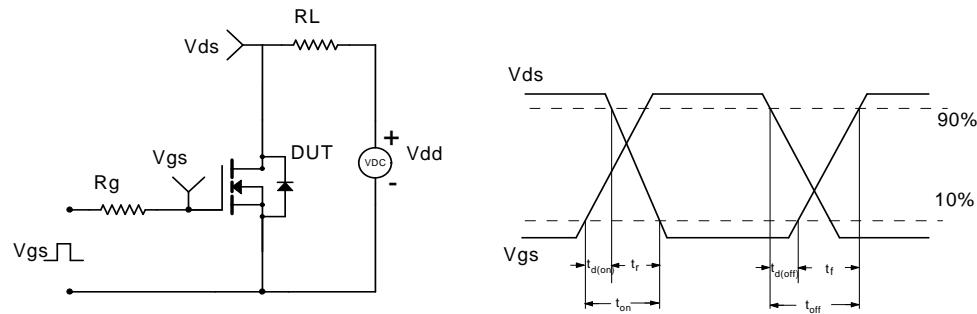


Figure 16: Normalized Maximum Transient Thermal Impedance (Note H)

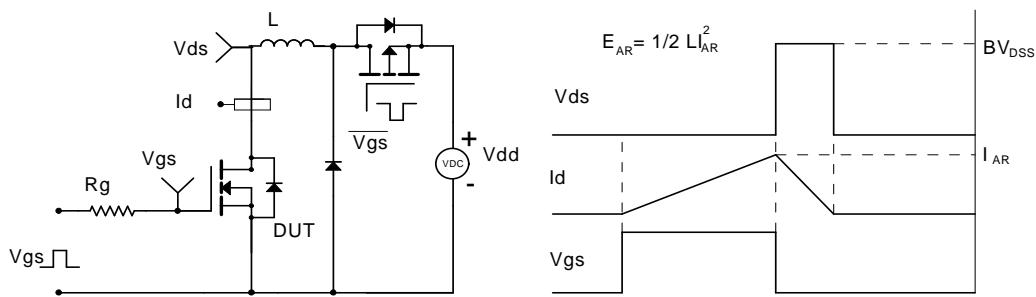
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms

